BT138F series E

GENERAL DESCRIPTION

Glass passivated, sensitive gate triacs in a full pack plastic envelope, intended for use in general purpose bidirectional switching and phase control applications, where high sensitivity is required in all four quadrants.

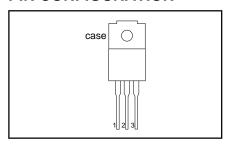
QUICK REFERENCE DATA

| SYMBOL | PARAMETER | MAX. | MAX. | MAX. | UNIT |
|-----------------------------------------|-----------------------------------------------------------------------------|-----------------|-----------------|--------------------|--------|
| V_{DRM} | BT138F- Repetitive peak off-state | 500E 500 | 600E 600 | 800E 800 | V |
| I _{T(RMS)} I _{TSM} | voltages RMS on-state current Non-repetitive peak on-state current | 12 90 | 12 90 | 12 90 | A A |

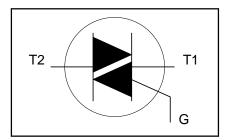
PINNING - SOT186

| PIN DESCRIPTION | |
|-----------------|-----------------|
| 1 | main terminal 1 |
| 2 | main terminal 2 |
| 3 | gate |
| case | isolated |

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | | MAX. | | UNIT |
|--------------------------------------------------------------|-------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------|----------|------------------------------|------------------------------|--------------------|------------------|
| V_{DRM} | Repetitive peak off-state voltages | | - | -500 500 ¹ | -600 600 ¹ | -800 800 | V |
| I _{T(RMS)} I _{TSM} | RMS on-state current Non-repetitive peak on-state current | full sine wave; $T_{hs} \le 56 ^{\circ}\text{C}$ full sine wave; $T_j = 125 ^{\circ}\text{C}$ prior to surge; with reapplied $V_{DRM(max)}$ | - | | 12 | | А |
| | | t = 20 ms | - | | 90 | | À |
| 124 | 124 for freeling | t = 16.7 ms | - | | 100 | | A |
| l²t dl _⊤ /dt | l ² t for fusing Repetitive rate of rise of on-state current after | I = 10 ms $I_{TM} = 20 \text{ A}; I_G = 0.2 \text{ A};$ $I_{G} = 0.2 \text{ A}$ | - | | 40 | | A ² s |
| | triggering | T2+ G+ | - | | 50 | | A/μs |
| | | T2+ G- | - | | 50 | | A/μs |
| | | T2- G- | - | | 50 | | A/μs |
| | | T2- G+ | - | | 10 | | A/μs |
| I _{GM} | Peak gate current | | - | | 2 | | A |
| V_{GM} | Peak gate voltage | | - | | 5 | | V |
| P_{GM} | Peak gate power | | - | | 5 | | W |
| $\begin{array}{c} P_{G(AV)} \\ T_{stg} \\ T_{j} \end{array}$ | Average gate power Storage temperature Operating junction temperature | over any 20 ms period | -40 - | | 0.5 150 125 | | ,C ,C |

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¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15 $A/\mu s$.

BT138F series E

ISOLATION LIMITING VALUE & CHARACTERISTIC

 T_{hs} = 25 °C unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-------------------|-----------------------------------------------------------------------|---------------------------------|------|------|------|------|
| V _{isol} | Repetitive peak voltage from all three terminals to external heatsink | R.H. ≤ 65% ; clean and dustfree | ı | | 1500 | > |
| C _{isol} | Capacitance from T2 to external heatsink | f = 1 MHz | - | 12 | 1 | pF |

THERMAL RESISTANCES

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------------------|---------------------|------------------------------------------------------------------------------------------|------|--------------|-----------------|-------------------|
| R _{th j-hs} | Thermal resistance | full or half cycle with heatsink compound without heatsink compound in free air | | - - 55 | 4.0 5.5 - | K/W K/W K/W |
| | junction to ambient | | | | | |

STATIC CHARACTERISTICS

T_i = 25 °C unless otherwise stated

| ij – 23 C utiless otitietwise stateu | | | | | | | |
|--------------------------------------|---------------------------|----------------------------------------------------------------------------------------------------------------------------|------|------|------|------|------|
| SYMBOL | PARAMETER | CONDITIONS | N | MIN. | TYP. | MAX. | UNIT |
| I _{GT} | Gate trigger current | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}$ | | | | | |
| | | T2+ | - G+ | - | 2.5 | 10 | mΑ |
| | | T2+ | - G- | - | 4.0 | 10 | mΑ |
| | | T2- (| G- | - | 5.0 | 10 | mΑ |
| | | T2- (| G+ | - | 11 | 25 | mΑ |
| I _L | Latching current | $V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$ | | | | | |
| | _ | T2+ | - G+ | - | 3.2 | 30 | mΑ |
| | | T2+ | - | - | 16 | 40 | mΑ |
| | | T2- (| | - | 4.0 | 30 | mΑ |
| | | T2- (| G+ | - | 5.5 | 40 | mΑ |
| I _H | Holding current | $V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$ | | - | 4.0 | 30 | mΑ |
| V_{T} | On-state voltage | I _⊤ = 15 A | | - | 1.4 | 1.65 | V |
| V _{GT} | Gate trigger voltage | $\dot{V}_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}$ | | - | 0.7 | 1.5 | V |
| | | $ V_D = 400 \text{ V}; I_T = 0.1 \text{ A}; T_L = 125 \text{ °C}$ | (| 0.25 | 0.4 | - | V |
| I_{D} | Off-state leakage current | $V_D = 400 \text{ V}; I_T = 0.1 \text{ A}; T_i = 125 ^{\circ}\text{C}$ $V_D = V_{DRM(max)}; T_j = 125 ^{\circ}\text{C}$ | | - | 0.1 | 0.5 | mA |

DYNAMIC CHARACTERISTICS

 $T_j = 25$ °C unless otherwise stated

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------------|--------------------------------------------|-------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| dV _D /dt | Critical rate of rise of off-state voltage | V _{DM} = 67% V _{DRM(max)} ; T _j = 125 °C; exponential waveform; gate open circuit | - | 50 | - | V/µs |
| t _{gt} | | $I_{TM} = 16 \text{ A}; V_D = V_{DRM(max)}; I_G = 0.1 \text{ A};$ $dI_G/dt = 5 \text{ A}/\mu\text{s}$ | - | 2 | - | μs |

BT138F series E

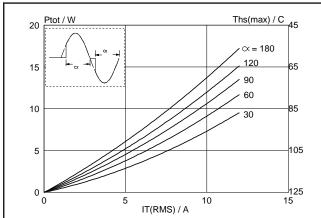


Fig.1. Maximum on-state dissipation, P_{tot} , versus rms on-state current, $I_{T(RMS)}$, where $\alpha =$ conduction angle.

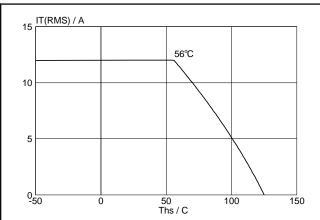


Fig.4. Maximum permissible rms current $I_{T(RMS)}$, versus heatsink temperature T_{hs} .

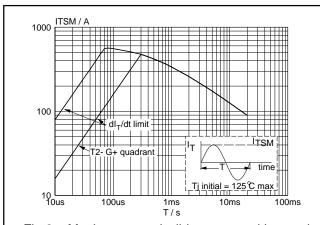


Fig.2. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus pulse width t_p , for sinusoidal currents, $t_p \le 20$ ms.

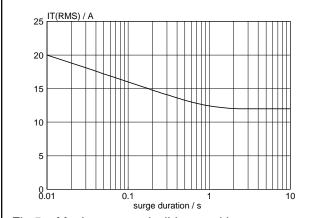


Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, f = 50 Hz; $T_{hs} \le 56$ °C.

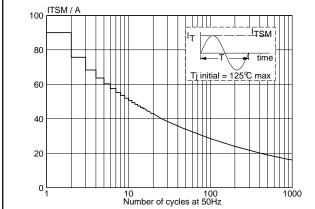


Fig.3. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus number of cycles, for sinusoidal currents, f = 50 Hz.

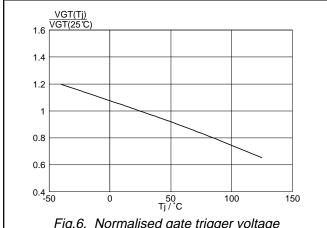
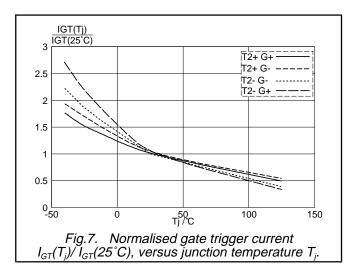
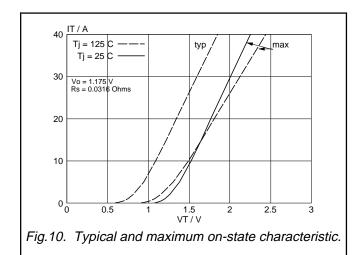
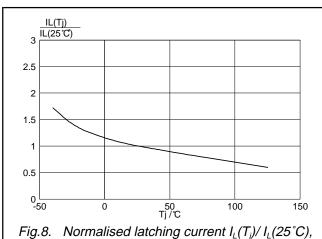


Fig.6. Normalised gate trigger voltage $V_{GT}(T_j)/V_{GT}(25\,^{\circ}C)$, versus junction temperature T_j .

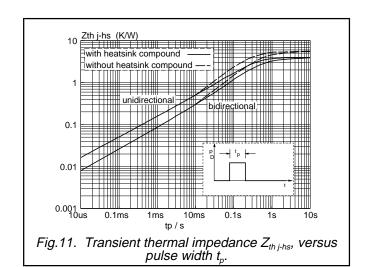
BT138F series E

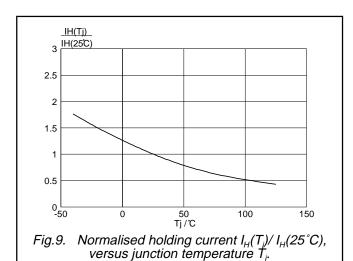






versus junction temperature T





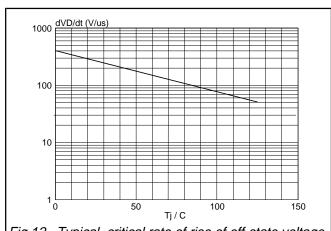
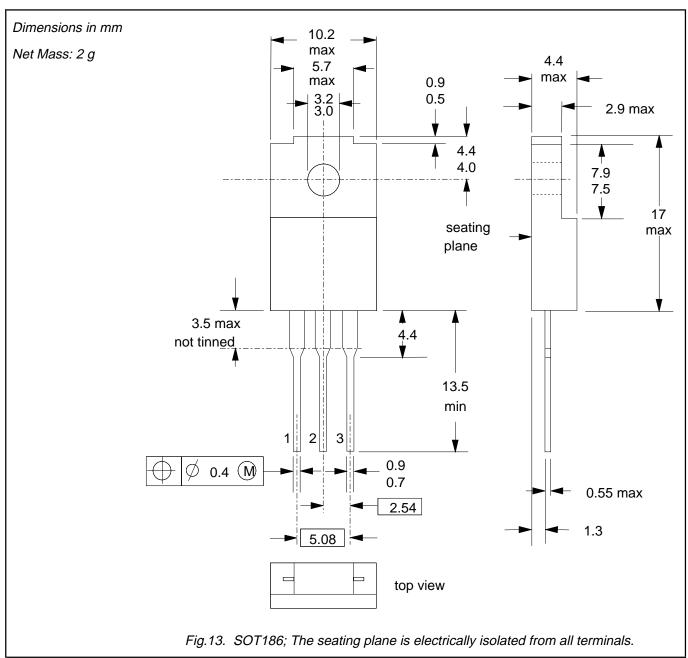


Fig.12. Typical, critical rate of rise of off-state voltage, dV_D/dt versus junction temperature T_i.

BT138F series E

MECHANICAL DATA



- Accessories supplied on request: refer to mounting instructions for F-pack envelopes.
 Epoxy meets UL94 V0 at 1/8".

Philips Semiconductors Product specification

Triacs sensitive gate

BT138F series E

DEFINITIONS

| Data sheet status | | | | | |
|---------------------------|---------------------------------------------------------------------------------------|--|--|--|--|
| Objective specification | This data sheet contains target or goal specifications for product development. | | | | |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. | | | | |
| Product specification | This data sheet contains final product specifications. | | | | |

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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